

Information Letter Number: 213702**Date:** 14.9.2021**Title:** Update of datasheet SGP40**Product Identification:** SGP40-D-R4 (3.000.384)**Reason for Change:**☒ Design☐ Production☐ Logistics☐ Manufacturing Location☐ Quality/Reliability☒ Upgrade**Change Description:**

In the Infoletter211901, Sensirion has informed about the change of timing of the built-in self-test command of SGP40 and the redefinition of the min/max limits of sensor performance. The updated datasheet v1.1 reflects those changes. Please, also note that the names of the commands have been slightly adapted without affecting the function of the interface itself. Furthermore, a command has been added to read out the sensor's serial number which can also be used for sensors which have already been purchased. A detailed description of all changes can be found in the revision history at the end of the datasheet.

Important to note: despite the change of the timing of the built-in self-test command, form, fit, and function of the SGP40 remain unaffected.

Identification Method to Distinguish Change:

None.

Samples:☐ available☐ will be available in☒ not applicable**Quantifiable Impact on Quality & Reliability:**

None.

Estimated Implementation Date*: 14.9.2021

* The Estimated Implementation Date is the forecasted date that a customer may expect to receive changed product. This may be affected by fluctuations in supply and demand.

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If you have questions with regard to this Information Letter, please send them to the Sensirion contact e-mail address listed above.

Datasheet SGP40

Indoor Air Quality Sensor for VOC Measurements

- MOx based gas sensor for indoor air quality applications
- Outstanding long-term stability and lifetime
- I²C interface with digital output signal
- Very small 6-pin DFN package: 2.44 x 2.44 x 0.85 mm³
- Low power consumption: 2.6 mA at 3.3 V
- Tape and reel packaged, reflow solderable



Product Summary

The SGP40 is a digital gas sensor designed for easy integration into air purifiers or demand-controlled ventilation systems. Sensirion's CMOSens® technology offers a complete, easy-to-use sensor system on a single chip featuring a digital I²C interface and a temperature-controlled micro hotplate, providing a humidity-compensated VOC based indoor air quality signal. The output signal can be directly processed by Sensirion's powerful VOC Algorithm to translate the raw signal into a VOC Index as a robust measure for indoor air quality. The VOC Algorithm automatically adapts to the environment the sensor is exposed to. Both sensing element and

VOC Algorithm feature an unmatched robustness against contaminating gases present in real-world applications enabling a unique long-term stability as well as low drift and device-to-device variation. The very small 2.44 x 2.44 x 0.85 mm³ DFN package enables applications in limited spaces. Sensirion's state-of-the-art production process guarantees high reproducibility and reliability. Tape and reel packaging together with suitability for standard SMD assembly processes make the SGP40 predestined for high-volume applications.

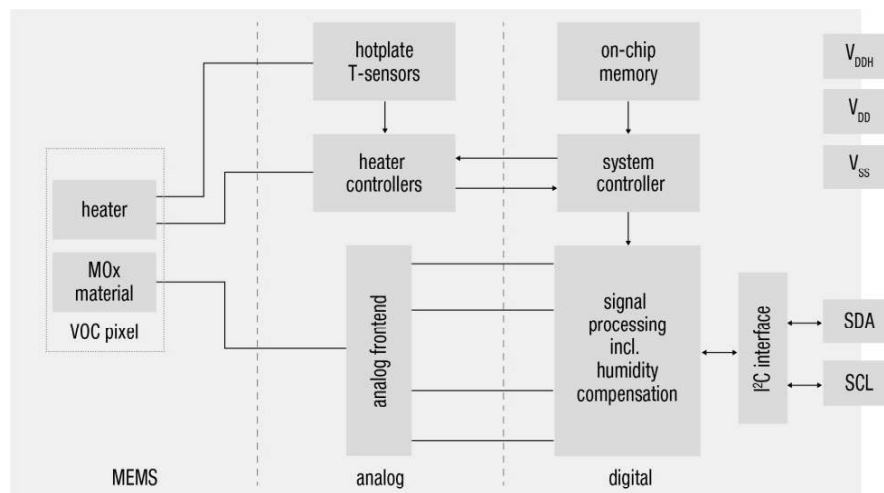


Figure 1 Functional block diagram of the SGP40.

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1 Sensor Performance

Table 1 lists specifications characterizing the gas sensing performance. The SGP40 chip provides a digital raw signal (SRAW_VOC) which is sensitive to most VOC gases typically present in indoor environments and which is proportional to the logarithm of the resistance of the sensing material. This signal is intended for further processing by an algorithm providing quantitative information about the VOC based indoor air quality. For this purpose, Sensirion offers its robust VOC Algorithm, which is included in the VOC Index driver package available on github (see SGP40 product page on Sensirion's webpage). The algorithm maps all VOC and fresh air events to a VOC Index scale (see 3.2 VOC Index Measurement). For the specifications given below, ethanol in clean air has been used as proxy gas for typical indoor air events.

Parameter	Comments		Values ¹			Units
			Min.	Typ.	Max.	
Output signals ²	VOC Index, processed value from SRAW_VOC		1	—	500	VOC Index points
	SRAW_VOC, digital raw value		0	—	65'535	ticks ³
Measurement range	Ethanol in clean air		0	—	1'000	ppm
Specified range	Ethanol in clear air		0.3	—	30	ppm
Device-to-device variation	VOC Index ⁴		—	<±15 <±15	—	VOC Index points or % m.v. (the larger)
Repeatability	VOC Index ⁴		—	<±5 <±5	—	VOC Index points or % m.v. (the larger)
Limit of detection ^{5,6}	Ethanol in specified range		—	—	<0.05 <10	ppm or % of concentration setpoint (the larger)
Response time	Changing concentration from 5 to 10 ppm of ethanol at sampling interval of 1 s	τ ₆₃	—	<10	—	s
		τ ₉₀	—	<30	—	s
Switch-on behavior	Time until reliably detecting VOC events ⁷		—	<60	—	s
	Time until specifications in this table are met		—	<1	—	h
Sensitivity ⁶	SRAW_VOC, doubling VOC concentration	Ethanol in specified range	—	–870	—	ticks
		5 to 10 ppm of ethanol	–710	–870	–1'030	ticks
Sampling interval	VOC Index		—	1	—	s
	SRAW VOC		0.5	1	10	s

Table 1 Gas sensing specifications at 25 °C and 50 % RH in zero air (considered as clean air for indoor air quality applications) and a power supply of VDD of 3.3 V. All concentrations refer to ethanol as test gas.

¹ 99 % of the sensors will be within the minimum–maximum tolerance. Typical tolerance refers to the mean of the distribution for ≥100 sensors.

² Humidity compensated when actual humidity value is provided as input to the sensor (see section 3.1 Raw Signal Measurement).

³ Signal in ticks is proportional to the logarithm of the resistance of the sensing layer.

⁴ Evaluated using the calibration and test sequence according to the application note *SGP40 – Testing Guide*.

⁵ Limit of detection is defined as the minimum change of concentration required to obtain a raw signal change 3 times higher than the noise at the given concentration setpoint.

⁶ Parameter tested over simulated lifetime of 10 years in an indoor environment. Test conditions: continuous operation in 250 ppm of Decamethylcyclopentasiloxane (D5).

⁷ Signal change during 60-s event of 5 to 10 ppm of ethanol is three times larger than signal drift without this event during the same duration.

Figure 2 displays the typical response of the raw signal of SGP40 to various VOCs as a function of their concentrations in otherwise clean air.

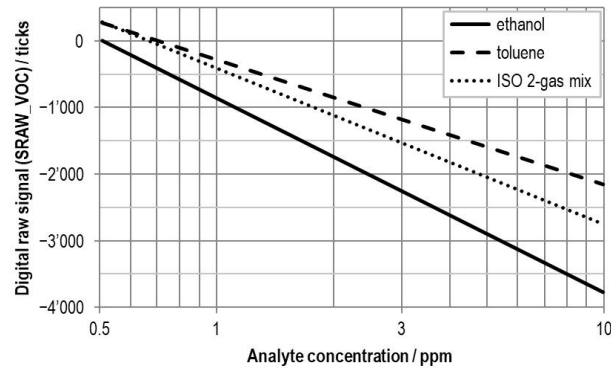


Figure 2 Typical sensor response to various VOCs normalized to 500 ppb of ethanol. ISO 2-gas mix according to ISO16000-29 is composed of *n*-octane and *m*-xylene in a molar ratio of 53:47. Data were recorded at 25 °C and 50 % RH and a power supply of VDD of 3.3 V.

2 Specifications

2.1 Electrical Specifications

Table 2 lists electrical specifications of the SGP40. Default conditions of 25 °C and 3.3 V supply voltage apply to values in the table below, unless otherwise stated. The SGP40 supports both I²C “standard-mode” and “fast-mode”.

Parameter	Symbol	Values			Unit	Comments
		Min.	Typ.	Max.		
Supply voltage, hotplate supply voltage ⁸	VDD, VDDH	1.7	3.3	3.6	V	Minimal voltage must be guaranteed also for the maximum supply current specified in this table. VDD and VDDH must be connected to the same power supply, see Figure 5 .
Idle current	IDD	–	34	105	μA	The idle mode is activated after power-up, after calling the <i>sgp4x_turn_heater_off</i> command, or after a soft reset.
Supply current under operation ⁹		–	3.5	4.0	mA	Average current consumption while the sensor is continuously operated at VDD, VDDH = 1.8 V.
		–	2.6	3.0	mA	Average current consumption while the sensor is continuously operated at VDD, VDDH = 3.3 V.
Communication	–	Digital 2-wire interface, I ² C				

Table 2 Electrical specifications.

2.2 Timing Specifications

Timings in **Table 3** refer to the power up and reset of the ASIC part and do not reflect the usefulness of the readings.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Power-up time	t _{PU}	After hard reset, VDD ≥ VPOR	–	0.4	0.6	ms
Soft reset time	t _{SR}	After soft reset	–	0.4	0.6	ms
SCL clock frequency	f _{SCL}	–	–	–	400	kHz

Table 3 System timing specifications.

2.3 Recommended Operating and Storage Conditions

Gas Sensing Specifications as detailed in **Table 1** are guaranteed only when the sensor is stored and operated under the recommended conditions as specified in **Table 4** and displayed in **Figure 3** and **Figure 4**. Prolonged exposure to conditions outside these conditions may reduce sensor performance. The sensor must not be exposed towards condensing conditions (*i.e.*, >90 % relative humidity) at any time.

⁸ Any supply voltage as defined by the min./max. range may be used for continuous operation of the sensor. The typical value specifies the supply voltage at which outgoing quality control is performed.

⁹ Sending the *sgp40_measure_raw_signal* command enables continuous operation of the sensor. A 20 % higher current is drawn during 5 ms on VDDH after entering the measurement mode.

Condition	Parameter	Min.	Max.	Unit
Operating conditions	Relative humidity	0	90	% RH
	Temperature	-10	50	°C
Operating conditions of humidity compensation	Humidity	1.5 (-13) –	30 (+31) 90 (the smaller)	g m ⁻³ (°C dew point) or % RH
	Temperature	-10	50	°C
Storage conditions	Relative humidity	0	80	% RH
	Temperature	5	30	°C

Table 4 Recommended humidity and temperature conditions for storing and operating the SGP40. Dew point refers to maximum humidity allowed at minimum and maximum temperature, respectively.

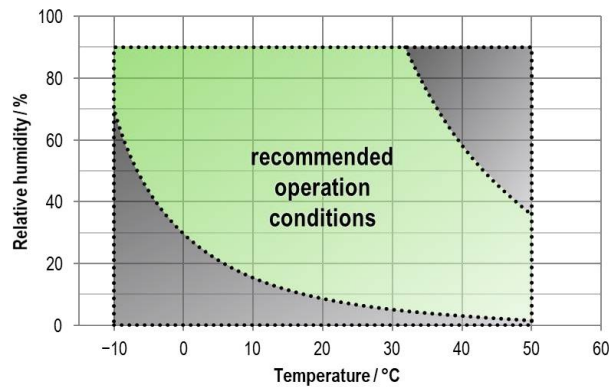


Figure 3 Recommended relative humidity and temperature for operating the SGP40. Green area marks conditions for which humidity compensation has been optimized. Additionally, gray areas mark operating conditions without considering the humidity compensation feature.

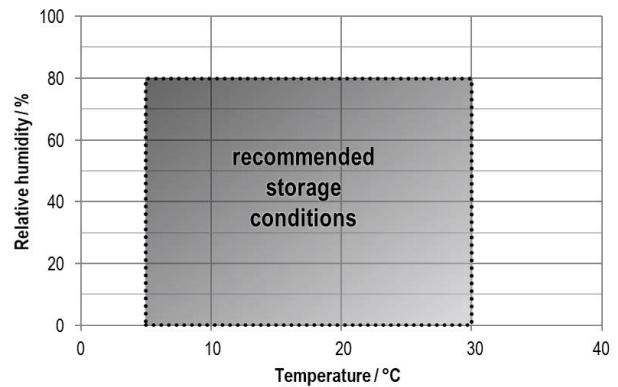


Figure 4 Recommended relative humidity and temperature for storing the SGP40.

To ensure an optimal performance of the SGP40, *Handling and Assembly Instructions for SGPxx Gas Sensors* as well as the *Design-in Guide for Integrating SGP4x Gas Sensors* need to be followed.

2.4 Absolute Minimum and Maximum Ratings

Stress levels beyond those listed in **Table 5** may cause permanent damage to the device. Exposure to minimum/maximum rating conditions for extended periods may affect sensor performance and reliability of the device.

Parameter	Rating
Supply voltage VDD	-0.3 to +3.6 V
Supply voltage VDDH	-0.3 to +3.6 V
Short-term storage temperature range ¹⁰	-40 to +70 °C
Operating temperature range	-20 to +55 °C
Short-term storage humidity range ¹⁰	0 to 80 % (non-condensing)
Operating humidity range	0 to 90 % (non-condensing)
ESD HBM	2 kV
ESD CDM	500 V
Latch up, JEDEC Class II, 125 °C	100 mA

Table 5 Absolute minimum and maximum ratings.

2.5 Hardware Interface Specifications

The SGP40 comes in a 6-pin DFN package, see **Table 6**. **Figure 5** shows a typical application circuit. The VDD pin must be decoupled with an RC element. The required decoupling for VDDH depends on the power supply network connected to the sensor, a capacitor of 1 μ F is recommended. VDD and VDDH must be connected to one single supply VDD. The external pull-up resistors (e.g., $R_p = 10 \text{ k}\Omega$) are required to pull the SDA and SCL signal lines high. For dimensioning resistor sizes please take bus capacity and communication frequency into account (see section 7.1 of *NXP I²C-bus specification and user manual* for more details). It should be noted that pull-up resistors may be included in I/O circuits of microcontrollers. The die pad or center pad is electrically connected to GND. Hence, electrical considerations do not impose constraints on the wiring of the die pad. However, for mechanical stability it is recommended to solder the die pad to the PCB.

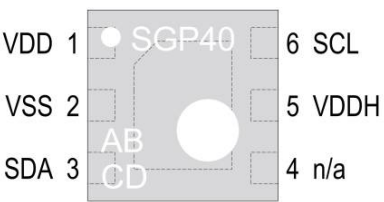
Pin	Name	Comments	
1	VDD	Supply voltage	
2	VSS	Ground	
3	SDA	Serial data, bidirectional	
4	n/a	Connect to ground (no electrical function)	
5	VDDH	Supply voltage, hotplate	
6	SCL	Serial clock, bidirectional	

Table 6 Pin assignment (transparent top view). Dashed lines are only visible from the bottom.

¹⁰ Short-term storage refers to temporary conditions during, e.g., transport.

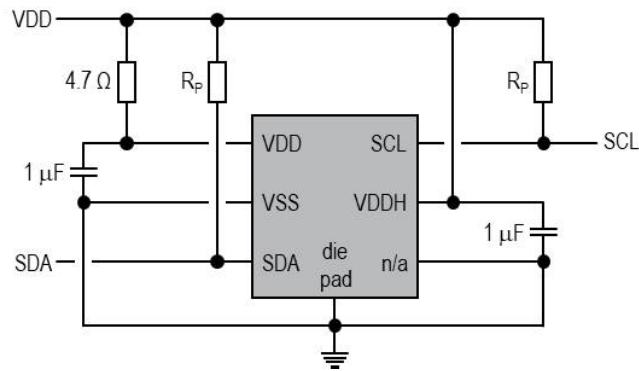


Figure 5 Typical application circuit.

2.6 Environmental Stability

The SGP40 has been qualified based on the JEDEC JESD47 qualification test method. The Moisture Sensitivity Level classification of the SGP40 is MSL1, according to IPC/JEDEC J-STD-020. At the same time, it is recommended to further process the sensors within 1 year after date of delivery. The SGP40 should not be exposed to bright illumination by either sunlight or artificial light sources during operation.

2.7 Material Contents

The device is fully RoHS, REACH, Halogen-free, and WEEE compliant, *e.g.*, free of Pb, Cd, and Hg.

3 Sensor Output Signal Description

3.1 Raw Signal Measurement

Calling the `sgp40_measure_raw_signal` command launches/continues the VOC measurement mode. It starts one measurement of the raw signal (SRAW_VOC) which is returned after 30 ms. Raw signal value in ticks is provided as one 16-bit word followed by one CRC byte (**Figure 6**). The raw signal in ticks is proportional to the logarithm of the sensor resistance. This signal is used as input for Sensirion's VOC Algorithm to provide a processed VOC Index (see section 3.2 VOC Index Measurement). In case the VOC Algorithm is not used, discard the first measured value. Typically, a measurement is performed every second by calling the `sgp40_measure_raw_signal` command again every second without turning the heater off. To exit the VOC measurement mode, the master calls the `sgp4x_turn_heater_off` command which switches off the hotplate and puts the sensor in idle mode.

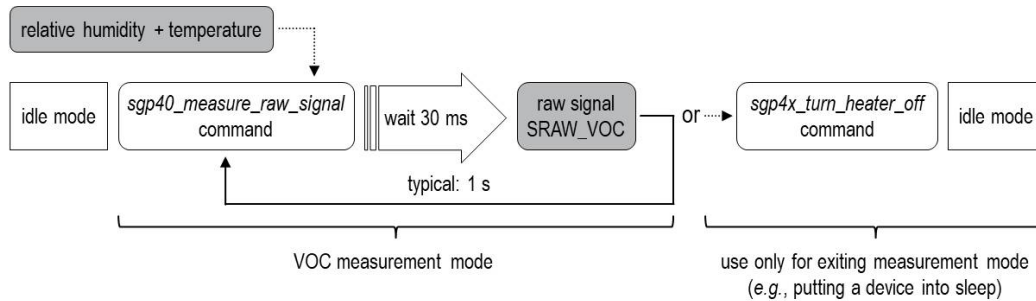


Figure 6 Process flow for performing a raw signal measurement with the SGP40. For enabling on-chip humidity compensation, current relative humidity and temperature values have to be supplied as part of the measurement command.

The SGP40 features an automatic on-chip humidity compensation of the raw signal. The feature remains disabled as long as default values for both humidity and temperature are sent together with the `sgp40_measure_raw_signal` command. For enabling the compensation, the measurement command includes two words (+ respective CRC bytes) where the first word represents the relative humidity and the second one represents the temperature.

3.2 VOC Index Measurement

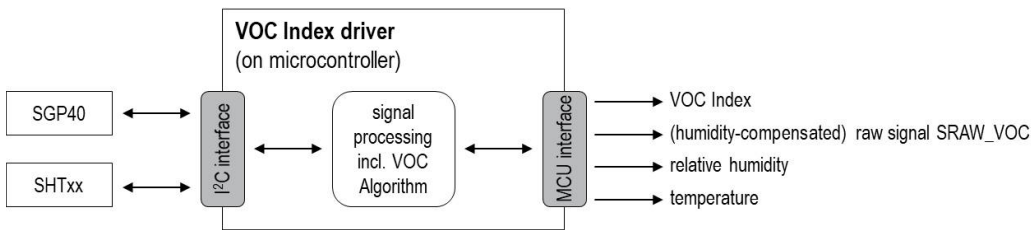


Figure 7 Schematic of the VOC Index driver.

For best performance in indoor-air-quality use cases, Sensirion recommends processing the (humidity-compensated) raw signal SRAW_VOC through Sensirion's powerful VOC Algorithm. The VOC Algorithm (**Figure 7**) automatically adapts its output to any indoor environment and maps all VOC events to a VOC Index scale ranging from 1 to 500 VOC Index points (**Figure 8**). The value 100 refers to the average indoor gas composition over the past 24 h. While values between 100 and 500 indicate a deterioration, values between 1 and 100 inform about improvement of the air quality. The VOC Algorithm is included in the VOC Index driver package available on github (see SGP40 product page on Sensirion's webpage). SGP40 raw signal needs to be provided to the VOC Algorithm at a sampling rate of 1 s.

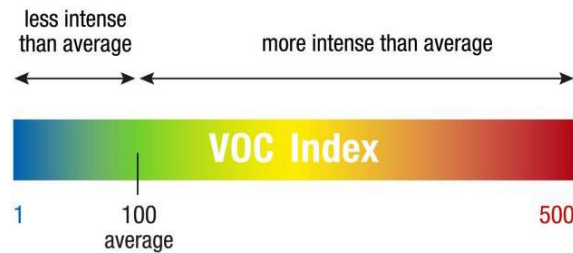


Figure 8 Explanation of the VOC Index scale.

3.3 Built-in Self-Test

With the *sgp40_execute_self_test* command, users can perform an on-chip self-test for, e.g., in-line or end-of-line production testing. If this command is called when the sensor is in idle mode, the sensor returns to idle mode after the test (**Figure 9**). In case this command is called during VOC measurement mode (i.e., after calling the *sgp40_measure_raw_signal* command), the hotplate remains switched on thereafter. After 320 ms, the master can read a fixed data pattern (1 word + CRC byte) to check if the test was successful or not.

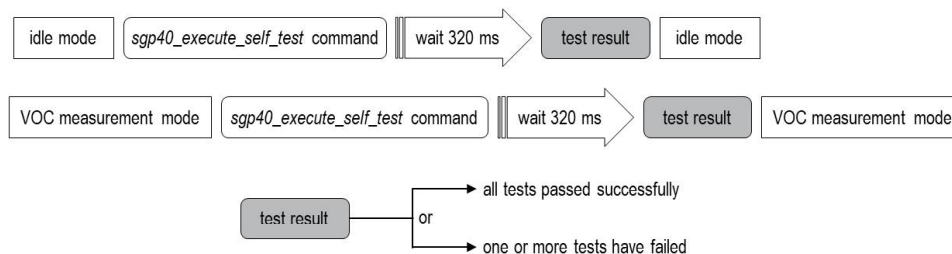


Figure 9 Possible ways of integrating the built-in self-test function.

3.4 Reading out The Sensor Serial Number

Every SGP40 sensor carries a unique serial number for identification purposes which is hard coded during sensor production. This number can be read out by using the *sgp4x_get_serial_number* command at any time in idle mode (**Figure 10**). After 1 ms, the chip responds with 3 words (each word followed by one CRC byte) which together constitute the serial number.



Figure 10 Process flow for reading out the serial number of the SGP40 sensor.

3.5 Sensor Start-up Behavior

The sensor starts powering-up after reaching the power-up threshold voltage of 1.7 V and enters idle mode after max. 0.6 ms. In this state, the sensor is ready to receive commands from the master.

4 Digital Interface Description

4.1 General Considerations

For driver integration incl. utilization of Sensirion's VOC Algorithm, please refer to the application note *SGP40 VOC Index Driver Integration*. For detailed information about the I²C protocol itself and its detailed implementation, please, consult the document *NXP I²C-bus specification and user manual*. All SGP40 commands consist of two bytes (16 bits). The commands must not be followed by a CRC. Additionally, data sent to and returned from the sensor is transferred in packets of two bytes (16 bits) followed by a 1-byte (8 bit) CRC.

4.2 I²C Address

The sensor's I²C address is 89 (decimal; hex.: 0x59). The I²C header is formed by the I²C address followed by a read or write bit.

4.3 I²C Voltage Levels

Input and output voltage levels are specified in section 6.1 of *NXP I²C-bus specification and user manual*. The sensor's interface is compatible with 1.7–3.6 V I²C bus voltage levels depending on the supply voltage level.

4.4 I²C Protocol Speed

The sensor supports I²C "standard-mode" and "fast-mode", with a maximum clock frequency of 100 or 400 kHz, respectively.

4.5 I²C Sequences

The typical communication sequence between the I²C master (e.g., a microcontroller in a host device) and the sensor is described as follows and visualized in **Figure 11**:

1. The sensor is powered up.
2. The I²C master periodically calls the measurement command and reads data in the following sequence:
 - a. I²C master sends a measurement command.
 - b. I²C master waits until the measurement is finished either by waiting for the maximum execution time or by waiting for the expected duration and then poll data until the read header is acknowledged by the sensor (expected durations are listed in **Table 8**).
 - c. I²C master reads out the measurement result.

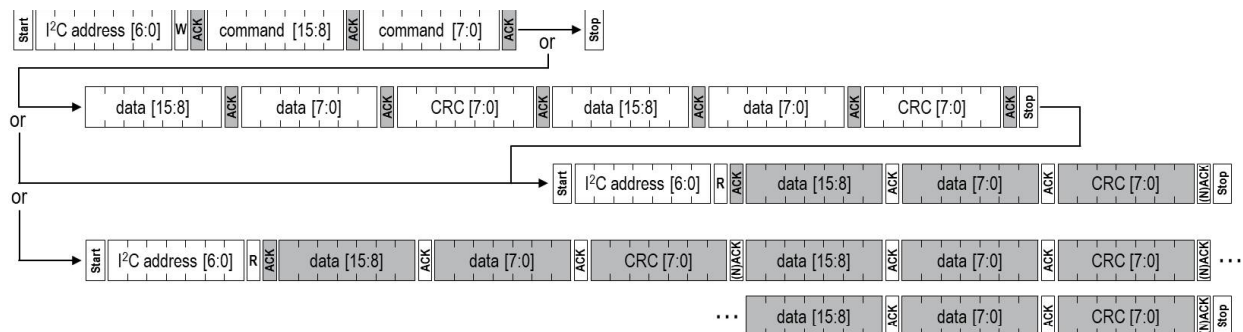


Figure 11 Possible I²C command sequences for communicating with the SGP40. Dark areas indicate that the sensor controls the SDA (data) line. First, the I²C master sends the write header writing a 16-bit command, potentially followed by two words of data with CRC bytes. For reading the measured data (from the built-in self-test and from the sensor measurement), the I²C master sends the read header and receives one word of data with CRC byte. In case of reading out the serial ID of the chip, the master receives three words with CRC bytes.

With the acknowledgement of the measurement command, the SGP40 starts measuring. When the measurement is in progress, no communication with the sensor is possible and the sensor aborts the communication with a NACK condition. After the sensor has completed the measurement, the master can read the measurement results by sending an I²C read header. The sensor will acknowledge the reception of the read header and responds with data. The response data length is listed in **Table 8** and is structured in data words, where one word consists of two bytes of data (most significant bit first) followed by a one-byte CRC

checksum. Each byte must be acknowledged by the master with an ACK condition for the sensor to continue sending data. If the sensor does not receive an ACK from the master after any byte of data, it will not continue sending data.

After receiving the checksum for the last word of data, a NACK and STOP condition have to be sent (see **Figure 11**). The I²C master can abort the read transfer with a NACK followed by a STOP condition after any data byte if it is not interested in subsequent data, e.g., the CRC byte or following data bytes, in order to save time. Note that the data cannot be read more than once, and access to data beyond the specified amount will return a pattern of high bits.

4.6 Checksum Calculation

The 8-bit CRC checksum transmitted after each data word is generated by the CRC algorithm according to the properties as stated in **Table 7**. The CRC covers the contents of the two previously transmitted data bytes.

Property	Value	Example code
Name	CRC-8	<pre>uint8_t CalcCrc(uint8_t data[2]) { uint8_t crc = 0xFF; for(int i = 0; i < 2; i++) { crc ^= data[i]; for(uint8_t bit = 8; bit > 0; --bit) { if(crc & 0x80) { crc = (crc << 1) ^ 0x31u; } else { crc = (crc << 1); } } } return crc; }</pre>
Width	8 bit	
Protected Data	read and/or write data	
Polynomial	0x31 (x ⁸ + x ⁵ + x ⁴ + 1)	
Initialization	0xFF	
Reflect input	False	
Reflect output	False	
Final XOR	0x00	
Examples	CRC (0xBE 0xEF) = 0x92	

Table 7 Checksums are used for the 2-byte data packets only. The command codes themselves already contain a 3-bit CRC and therefore, a checksum must not be appended.

4.7 I²C Commands

The available measurement commands of the SGP40 are listed in **Table 8**.

Command	Command hex. code	Parameter length including CRC [bytes]	Response length including CRC [bytes]	Measurement duration [ms]	
				Typ.	Max.
<i>sgp40_measure_raw_signal</i>	0x26 0x0F	6	3	25	30
<i>sgp40_execute_self_test</i>	0x28 0x0E	–	3	300	320
<i>sgp4x_turn_heater_off</i>	0x36 0x15	–	–	0.1	1
<i>sgp4x_get_serial_number</i>	0x36 0x82	–	9	0.1	1

Table 8 I²C commands available for SGP40.

Measure Raw Signal

Command	Subcommand	Command hex. code	Description
<i>sgp40_measure_raw_signal</i>	Without humidity compensation	0x26 0x0F 0x80 0x00 0xA2 0x66 0x66 0x93	This command starts/continues the VOC measurement mode, leaves humidity compensation disabled by sending the default values (see Table 10), and returns the measured raw signal SRAW_VOC as 2 bytes (+ 1 CRC byte).
	With humidity compensation	0x26 0x0F 0xXX 0xXX 0xXX 0xYY 0xYY 0xYY	In order to enable the humidity compensation, the master has to specify the relative humidity 0xXX 0xXX 0xXX and temperature 0xYY 0xYY 0xYY input (incl. corresponding CRC bytes) in the format as given in Table 10 .

Table 9 Description of the I²C measurement command.

	Relative Humidity		Temperature	
	Value / %	Hex. code	Value / °C	Hex. code
Conversion into ticks	$RH/ticks = RH/\% \times \frac{65'535}{100}$		$T/ticks = (T/^{\circ}C + 45) \times \frac{65'535}{175}$	
Default	50	0x80 0x00 + CRC 0xA2	25	0x66 0x66 + CRC 0x93
Minimum	0	0x00 0x00 + CRC 0x81	-45	0x00 0x00 + CRC 0x81
Maximum	100	0xFF 0xFF + CRC 0xAC	130	0xFF 0xFF + CRC 0xAC

Table 10 Conversion of relative humidity in % and temperature in °C into ticks as the input parameters of the measurement command. Note: minimum and maximum values do not reflect the range of conditions for which the humidity compensation feature has been optimized. For details see **Table 4**.

Byte number	Description	Value
0, 1	two bytes	u16 unsigned integer directly provides the raw signal SRAW_VOC in ticks which is proportional to the logarithm of the resistance of the sensing element.
2	CRC byte for bytes 0, 1	–

Table 11 Returned values by the I²C measurement command.

Built-in Self-Test

Command	Command hex. code	Description
<i>sgp40_execute_self_test</i>	0x28 0x0E	This command triggers the built-in self-test checking for integrity of both hotplate and MOX material and returns the result of this test as 2 bytes (+ 1 CRC byte).

Table 12 Description of the I²C built-in self-test command.

Byte number	Description	Value
0, 1	two bytes	0xD4 0xXX: all tests passed successfully (ignore 0xXX byte) 0x4B 0xXX: one or more tests have failed (ignore 0xXX byte)
2	CRC byte for bytes 0, 1	–

Table 13 Returned values by the I²C built-in self-test command.

Turn Heater off and Return to Idle Mode

Command	Command hex. code	Description
<i>sgp4x_turn_heater_off</i>	0x36 0x15	This command turns the hotplate off and stops the measurement. Subsequently, the sensor enters idle mode.

Table 14 Description of the I²C heater off command.

Read out The Sensor Serial Number

Command	Command hex. code	Description
<i>sgp4x_get_serial_number</i>	0x36 0x82	This command provides the decimal serial number of the SGP40 chip by returning 3x2 bytes (+ 1 CRC byte).

Table 15 Description of the I²C get serial number command.

Byte number	Description	Value
0, 1	two bytes	First (<i>i.e.</i> , most significant) and second byte of the serial number.
2	CRC byte for bytes 0, 1	–
3, 4	two bytes	Third and fourth byte of the serial number.
5	CRC byte for bytes 3, 4	–
6, 7	two bytes	Fifth and sixth (<i>i.e.</i> , least significant) byte of the serial number.
8	CRC byte for bytes 6, 7	–

Table 16 Returned values by the I²C get serial number command.

Soft Reset

Command	Command hex. code	Description
<i>soft_reset</i>	0x00 0x06	This command is a general call resetting all devices connected to the same I ² C bus. The first byte refers to the general call address and the second byte refers to the reset command. After calling this command, the SGP40 will restart entering the idle mode.

Table 17 Description of the I²C general soft reset command.

5 Mechanical Specifications

SGP40 sensors are provided in a DFN (dual flat no leads) package with an outline of $2.44 \times 2.44 \times 0.85 \text{ mm}^3$ and a terminal pitch of 0.8 mm. The sensor opening with a typical diameter of 0.8 mm is offset to the bottom right corner on the top side of the package. The sensor chip is assembled on a Ni/Pd/Au plated copper lead frame. Sensor chip and lead frame are over-molded by a black, epoxy-based mold compound. Please note that the side walls of the package are diced and therefore the lead frame sidewall surfaces are not plated.

5.1 Traceability

All SGP40 sensors are laser marked for easy identification and traceability (**Figure 12**). The marking on the sensor top side consists of a pin-1 indicator and three lines of text. The top line consists of the pin-1 indicator which is located in the top left corner and the product name. The two lines at the bottom consist of 2 alphanumeric digits each. That code can be decoded by Sensirion only and allows for tracking on batch level through production, calibration, and testing – and will be provided upon justified request.

If viewed from below pin 1 is indicated by triangular shaped cut in the otherwise rectangular die pad. The dimensions of the triangular cut are shown in **Figure 13**, right. The sensor opening on the top side is not recommended for optical alignment.



Figure 12 Top view of the SGP40 illustrating the laser marking.

5.2 Package Outline

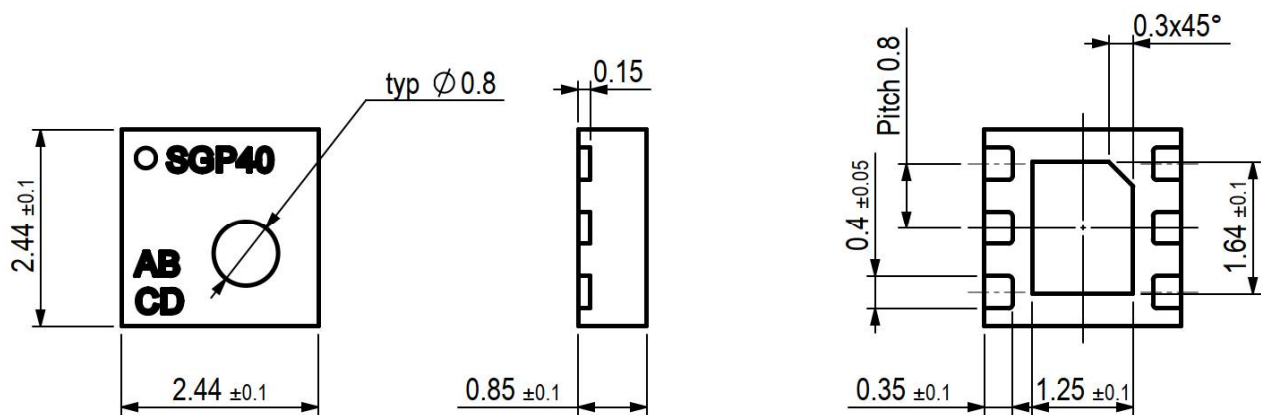


Figure 13 Package outline drawing of the SGP40. Dimensions are given in millimeters.

5.3 Land Pattern

Recommended land pattern of the SGP40 is shown in **Figure 14**. Pads on PCB are recommended to be non-solder mask defined (NSMD). Recommended solder paste stencil thickness is 125–150 μm .

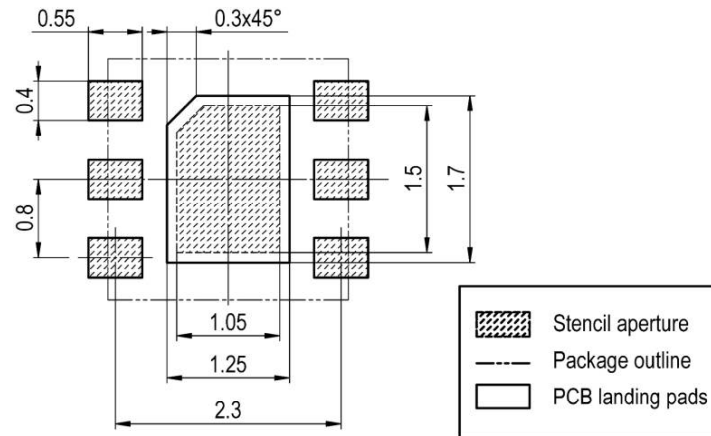


Figure 14 Recommended land pattern.

5.4 Soldering Instructions

Standard reflow soldering ovens and “no clean” type 3 solder paste (as specified in IPC J-STD-005A) should be used for soldering the SGP40. The sensors are designed to withstand a soldering profile according to IPC/JEDEC J-STD-020. Peak temperatures of $T_P = 245\text{ }^{\circ}\text{C}$ during up to $t_p = 30\text{ s}$ for Pb-free assembly in IR/Convection reflow ovens (see **Figure 15**) are recommended. In addition, we also recommend a maximum ramp-down rate of $<4\text{ }^{\circ}\text{C s}^{-1}$. Vapor phase or manual soldering should not be used in order to avoid damaging of the sensor. In case the PCB hosting the SGP40 chip passes through multiple solder cycles, it is recommended to assemble the SGP40 during the last solder cycle. Board wash and ultrasonic cleaning should be avoided. For general information (such as conformal coating), please also refer to the *Handling and Assembly Instructions for SGPxx Gas Sensors*.

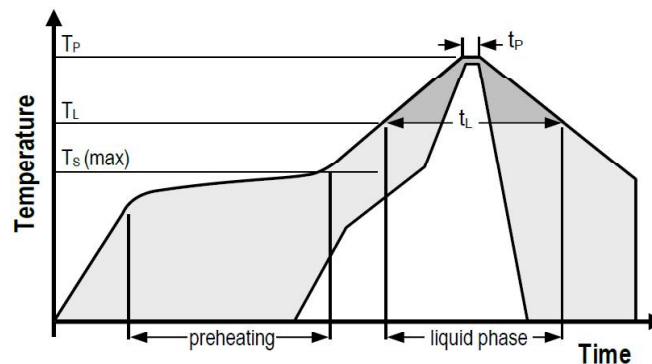


Figure 15 Soldering profile according to JEDEC standard. Recommended conditions are $T_P = 245\text{ }^{\circ}\text{C}$ and $t_p \leq 30\text{ s}$ for Pb-free assembly, $T_L < 220\text{ }^{\circ}\text{C}$ and $t_L < 150\text{ s}$. Ramp-up rate $<3\text{ }^{\circ}\text{C s}^{-1}$ and ramp-down rate $<4\text{ }^{\circ}\text{C s}^{-1}$.

6 Ordering Information

Use the part names and product numbers shown in the following table when ordering the SGP40 gas sensor. For the latest product information and local distributors, visit www.sensirion.com.

Part Name	Description	Ordering size	Product Number
SGP40-D-R4	SGP40 sensor components as tape on reel	2'500 pcs	3.000.384

Table 18 SGP40 ordering options.

6.1 Packaging Information

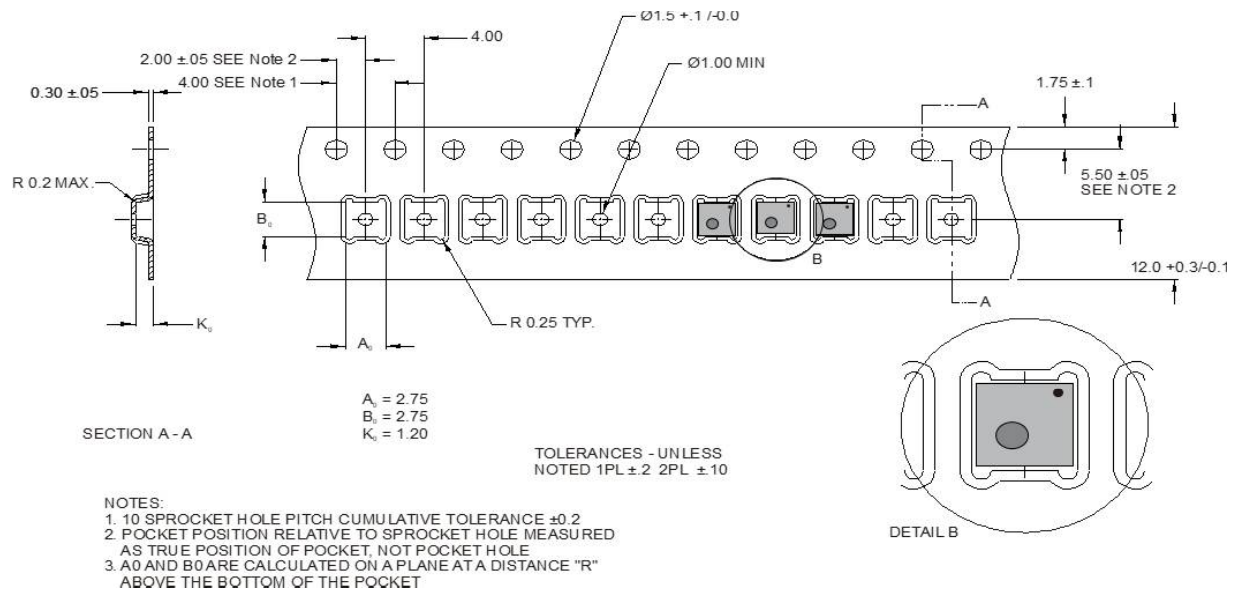


Figure 16 Technical drawing of the packaging tape with sensor orientation in tape. Header tape is to the right and trailer tape to the left on this drawing. Dimensions are given in millimeters.

Important Notices

Warning, Personal Injury

Do not use this product as safety or emergency stop devices or in any other application where failure of the product could result in personal injury. Do not use this product for applications other than its intended and authorized use. Before installing, handling, using or servicing this product, please consult the data sheet and application notes. Failure to comply with these instructions could result in death or serious injury.

If the Buyer shall purchase or use SENSIRION products for any unintended or unauthorized application, Buyer shall defend, indemnify and hold harmless SENSIRION and its officers, employees, subsidiaries, affiliates and distributors against all claims, costs, damages and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if SENSIRION shall be allegedly negligent with respect to the design or the manufacture of the product.

ESD Precautions

The inherent design of this component causes it to be sensitive to electrostatic discharge (ESD). To prevent ESD-induced damage and/or degradation, take customary and statutory ESD precautions when handling this product. See application note "ESD, Latchup and EMC" for more information.

Warranty

SENSIRION warrants solely to the original purchaser of this product for a period of 12 months (one year) from the date of delivery that this product shall be of the quality, material and workmanship defined in SENSIRION's published specifications of the product. Within such period, if proven to be defective, SENSIRION shall repair and/or replace this product, in SENSIRION's discretion, free of charge to the Buyer, provided that:

- notice in writing describing the defects shall be given to SENSIRION within fourteen (14) days after their appearance;
- such defects shall be found, to SENSIRION's reasonable satisfaction, to have arisen from SENSIRION's faulty design, material, or workmanship;
- the defective product shall be returned to SENSIRION's factory at the Buyer's expense; and
- the warranty period for any repaired or replaced product shall be limited to the unexpired portion of the original period.

This warranty does not apply to any equipment which has not been installed and used within the specifications recommended by SENSIRION for the intended and proper use of the equipment. EXCEPT FOR THE WARRANTIES EXPRESSLY SET FORTH HEREIN, SENSIRION MAKES NO WARRANTIES, EITHER EXPRESS OR IMPLIED, WITH RESPECT TO THE PRODUCT. ANY AND ALL WARRANTIES, INCLUDING WITHOUT LIMITATION, WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE, ARE EXPRESSLY EXCLUDED AND DECLINED.

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Revision History

Date	Version	Page(s)	Changes
July, 2020	1.0	All	Initial release
September, 2021	1.1	Multiple	Typo and formatting corrections
		3	Updated footnote 1
		4	Updated caption of Figure 2
		8	Updated Figure 5
		9	Updated description in section 3.1 Raw Signal Measurement
		9	Updated Figure 8
		9, 12, 13	Renamed measure command in Figure 6 , Table 8 , and Table 9
		9, 12, 14	Renamed turn heater off command in Figure 6 , Table 8 , and Table 14
		10, 12, 13	Renamed self-test command in Figure 9 , Table 8 , and Table 12
		10, 12, 14	Added command <i>sgp4x_get_serial_number</i> and added section 3.4 Reading out The Sensor Serial Number, Table 8 , Table 15 , and Table 16
		11	Updated Figure 11
		13	Updated description of measurement command with humidity compensation in Table 9
		14	Updated returned values of self-test command in Table 13

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